AMD Alchemy[™] Solutions and **AMD Geode[™] Solutions Product Selection Guide**







AMD offers a broad range of low-power processors and design tools that help customers to design the right product quickly for their target application. Two processor families are available: the AMD Alchemy™ and AMD Geode™ families:

- · AMD Alchemy Solutions are ideally suited for low-power, high-performance applications such as PDAs (Personal Digital Assistants), Web tablets, portable and wired Internet access devices, and gateways.
- AMD Geode Solutions leverage proven mobile technology to give designers a broad range of low-power, high-performance x86 capabilities for designing a variety of applications, including thin-client and peripheral devices - backed by the AMD commitment to long-term support of the x86 marketplace.

Both families of processors are backed by a set of development tools including Reference Design Kits and Development Boards.

- · Reference Design Kits (RDKs) are complete reference design solutions that help enable the customer to get from concept to actual product in a short period of time. The RDK is a manufactured product that is available for demonstration and includes all the information required for a customer to recreate the design. As an alternative, the solution is available from a partner for direct purchase. In addition, as part of the kit, documentation is supplied that helps enable the customer to extend the design by adding features from option schematic pages or by making their own design choices for either hardware or software. The RDK is the right place for a customer to begin their design process.
- Development Boards help enable developers to write and test software code and to simulate hardware for their applications. They are highly configurable and allow customers to use all of the features of the processor, either natively on the board or via a plug-in card. While not ideal as a starting point for customer designs, they do allow a customer to begin their software development in parallel with the hardware to reduce the overall time-to-market.

Reference Design Kits																									
			OS (Note I)			I/O Connectors													Typical Kit Contents						
Name	Processor	Companion Device	Form Factor (Inches)	Video Output	Windows® XP/XPe	Windows CE 4.2	Linux 2.4.x	Audio Out Channels	USB	PCI Slots	LPC Slots or Headers	Super I/O on Board	Ethernet on Board	Power	Serial ATA	IDE UDMA	Serial Ports	PS/2 Keyboard/Mouse	Parallel Port	IrDA	5.0V to 3.3V PCI Card	TFT Interface Card	LPC Card with Super I/O	PCI Ethernet Card	CD-ROM/Std. Documentation
AMD Alchemy™	' Solutions																								
Portable Media Tablet	Aul500™	N/A	10x14x2 (Note 2)	LCD		1	1	2	3	I												1		1	1
Mobile Handheld	Aull00™	N/A	5x3x0.5	LCD		1	1	ı												ı		1			1
Access Equipment	AuI500™	N/A	7x6xI	CRT		1	1		2	ı			2				I								1
AMD Geode™ S	olutions																								
GX Thin Client	Geode GX 533 @ I.IW (Note 3)	AMD CS5535	55x5x12.5	CRT	1	1	1	I	4		I		I	12VDC		1									1
GX SOM-144	Geode GX 533@ I.IW (Note 3)	AMD CS5535	2.75x4	CRT TFT	1	1	1																		1

OS support typically includes BIOS and drivers for audio, display, and bootloader if required.

The Portable Media Tablet supports the mini PCI form factor only Note 2.

Note 3. The Geode GX 533@I.IW processor operates at 400 MHz. Model numbers reflect performance as described here:

http://www.amd.com/connectivitysolutions/geodegxbenchmark.



Processors

Processor Family	Device Number	Companion Device(s)	Package/Operating Case Temperature	Core Freq. (Perform. Rating)	Core Volt	Thermal Design Power	Power Management/ Rating	FPU	Memory Support	PCI	Ethernet	IDE	USB	LPC	Audio	UART/IR	Serial/ Parallel Interfaces	RTC	MAX GPI0s	Security	Video: Max Resolution
AMD Alchemy™ Au Processors	Au1550™ (System On Chip)	N/A	LF-PBGA483 0°C to 85°C LF-PBGA483	500 MHz 400 MHz 333 MHz	1.2V	1.6W 1.5W	Idle, Sleep, Hibernate	MIPS32™	DDR333/SDR125 DDR400/SDR100 DDR333/SDR81	v2.2	2 10/100 MAC Controllers	No	2 Ports, vl.I w/OTG	No	AC97 v2.3	3	SPI, I ² S, SMBus, PCMCIA	I and TOY with Battery Backup	43	IPsec, SSL	PCI Video
	A FRONTI		0°C to 85°C -40°C to 100°C								2.10.110				1.007						
	AuI500™ (System On Chip)	N/A	LF-PBGA424 0°C to 50°C LF-PBGA424 0°C to 70°C	500 MHz 400 MHz	1.8V 1.5V	2.5W 1.6W	Idle, Sleep	MIPS32	SDRI25 SDRI00	v2.2	2 10/100 MAC Controllers	No	2 Ports, vl.l	No	AC97 vl.x	2	PCMCIA	1	39	No	PCI Video
	Au1200™ (System On Chip)	N/A	LF-PBGA372 0°C to 85°C	333 MHz 500 MHz 400 MHz	1.2V	TBD TBD	IdleO, IdleI, Sleep, Hibernate	MIPS32	SDR81 DDR400/ DDR2-533	No	No	IDE PIO Mode 4	2 Ports, v2.0 w/OTG	No	AC97 v2.3	2	SPI, I ² S, SMBus, PCMCIA,	I and TOY with Battery	48	128-Bit AES	Video Decode, Camera, LCD, TFT and STN
				333 MHz		TBD											PCMCIA, CCIR656	Backup '			
	Aull00™ (System On Chip)	N/A	LF-PBGA399 0°C to 70°C	500 MHz 400 MHz 333 MHz	1.1V to 1.3V	0.9W 0.6W 0.5W	Idle, Sleep	MIPS32	SDR125 SDR100 SDR81	_ No	I 10/100 MAC Controller	No	2 Ports, vl.l	No	AC97 vl.x	3	I ² S, SSI, IrDA, PCMCIA	2	48	No	LCD, TFT and STN
	Au1000™ (System On Chip)	N/A	LF-PBGA324 0°C to 70°C	500 MHz 400 MHz	1.8V 1.5V	1.9W 1.2W	Idle, Sleep	MIPS32	SDR125 SDR100	No	2 10/100 MAC Controllers	No	2 Ports, vl.l	No	AC97 vl.x	4	I ² S, SSI, IrDA, PCMCIA	2	32	No	LCD, TFT and STN
			LF-PBGA324 0°C to 70°C -40°C to 85°C	266 MHz		844mW			SDR81												
AMD Geode™ NX	Geode NX 1750 @ 14W (Mobile AMD Athlon™	SiS 741CX/963L or 964	OPGA - Socket A 0°C to 95°C	1.4 GHz (1750)	1.05V to 1.25V	25W	ACPI vI.0b/v2.0, AMD PowerNow!™ technology	MMX,® 3DNow!™	DDR333	v2.2/v2.3	l 10/100 MAC Controller	2 Ch., UDMA-133, 2 S-ATA (964)	6/8 Ports, v2.0/1.1	2 LDRQs	AC97 v2.2/v2.3	No	No	I	25	No	CRT: 2048xI536 TFT: 1600xI200
	Processor Technology) (Note I)	VIA KN400A/ VT8237					ACPI v2.0, AMD PowerNow! technology	technology		v2.2	l 10/100 MAC Controller	2 Ch., UDMA-133, 2 S-ATA	8 Ports, v2.0/1.1	2 LDRQs	AC97 v2.1	No	No	I	35	No	CRT, TFT: 1600x1200
	Geode NX 1500 @ 6W (Mobile AMD Athlon Processor Technology)	SiS 741CX/963L or 964	OPGA - Socket A 0°C to 95°C	1.0 GHz (1500)	1.0V	9W	ACPI v1.0b/v2.0, AMD PowerNow! technology	MMX, 3DNow!	DDR333	v2.2/v2.3	l 10/100 MAC Controller	2 Ch., UDMA-133, 2 S-ATA (964)	6/8 Ports, v2.0/1.1	2 LDRQs	AC97 v2.2/v2.3	No	No	I	25	No	CRT: 2048xI536 TFT: 1600xI200
	(Note I)	VIA KN400A/ VT8237					ACPI v2.0, AMD PowerNow! technology	technology		v2.2	l 10/100 MAC Controller	2 Ch., UDMA-133, 2 S-ATA	8 Ports, v2.0/1.1	2 LDRQs	AC97 v2.I	No	No	I	35	No	CRT, TFT: 1600x1200
	Geode NX 1250 @ 6W (Mobile AMD Athlon Processor Technology)	SiS 741CX/963L or 964	OPGA - Socket A 0°C to 95°C	667 MHz (1250)	1.1V	9W	ACPI v1.0b/v2.0, AMD PowerNow! technology	MMX, 3DNow!	DDR333	v2.2/v2.3	l 10/100 MAC Controller	2 Ch., UDMA-133, 2 S-ATA (964)	6/8 Ports, v2.0/1.1	2 LDRQs	AC97 v2.2/v2.3	No	No	I	25	No	CRT: 2048xI536 TFT: I600xI200
	(Note I)	VIA KN400A/ VT8237					ACPI v2.0, AMD PowerNow! technology	technology		v2.2	l 10/100 MAC Controller	2 Ch., UDMA-133, 2 S-ATA	8 Ports, v2.0/1.1	2 LDRQs	AC97 v2.I	No	No	I	35	No	CRT, TFT: 1600x1200
AMD Geode™ GX Processors (Note 2)	Geode GX 533 @ 1.1W (Integrated North Bridge/Graphics) (Note 2)	AMD CSSS3S	BGD368 0°C to 85°C BGU396 0°C to 85°C	400 MHz (533)	1.5V	<3.5W	ACPI v2.0	MMX, 3DNow! technology	DDR266	v2.2	No	I Ch., UDMA-66	4 Ports, vl.l	I LDRQ	AC97 v2.1	2/I	ACCESS.bus w/2 Ports	I	32	No	CRT or TFT: 1600x1200 CRT, TFT: 1600x1200
	Geode GX 500 @ 1.0W (Integrated North Bridge/Graphics)	AMD CSSS3S	BGD368 0°C to 85°C BGU396	366 MHz (500)	1.5V	<3.5W	ACPI v2.0	MMX, 3DNow! technology	DDR244												CRT or TFT: 1600x1200
	(Note 2) Geode GX 466@0.9W	AMD CSS535	0°C to 85°C	333 MHz	1.5V	<3.5W	ACPI v2.0	MMX	DDR222	-											CRT or TFT: 1600x1200
AMD Alchemy™ Au Processors Al (S (S (S (S (S (S (S (S (S ((Integrated North Bridge/Graphics) (Note 2)	THIS CSSSS	0°C to 85°C BGU396 0°C to 85°C	(466)	,	3.511	NC1172.0	MMX, 3DNow! technology	JUNETE												CRT, TFT: 1600x1200
	Geode GXI (Note 3)	AMD CSSS30A	BGD352 0°C to 85°C	333 MHz	2.2V 2.0V	5.9W 4.8W	ACPI vI.0	MMX	SDRIII	v2.I	No	2 Ch., UDMA-33	2 Ports, vl.0	No	AC97 v2.1	No	No	I	8	No	CRT: 1280x1024
	(note 3)			300 MHz 266, 233, 200 MHz	1.8V	4.0W 4.IW			SDR100 SDR89												
Geode™ SC	SCIIOO (System On Chip)	N/A	BGU388 0°C to 85°C	266 MHz 233 MHz	2.0V 1.8V	3.3W 2.7W	ACPI vI.0	ММХ	SDR89	v2.I	No	I Ch., UDMA-33	3 Ports, vl.0	I LDRQ	AC97 v2.0	I	ACCESS.bus w/2 Ports	I	30	No	N/A
Frocessors	SCI200/SCI201 (System On Chip)	N/A	BGD432, BGU48I 0°C to 85°C	266 MHz	1.8V	3.3W	ACPI vI.0	MMX	SDRIOO	v2.I	No	2 Ch., UDMA-33	3 Ports, vl.0	I LDRQ	AC97 v2.0	3/I	ACCESS.bus w/2 Ports, I Parallel Port	I	27	No	CRT, TFT: I280xI024 TV: NTSC/PAL
	SC2200 (System On Chip)	N/A	BGD432, BGU481 0°C to 85°C BGU481 0°C to 85°C	300 MHz 266 MHz 233 MHz	2.IV 1.8V 1.8V	4.IW 3.IW 2.9W	ACPI vI.O	MMX	SDR100	v2.I	No	2 Ch., UDMA-33	3 Ports, vl.0	I LDRQ	AC97 v2.0	3/I	ACCESS.bus w/2 Ports, I Parallel Port	I	27	No	CRT, TFT: 1280x1024
	SC3200 (System On Chip)	N/A	BGD432, BGU48I 0°C to 85°C BGU48I 0°C to 85°C	266 MHz 233 MHz	1.8V	3.0W 2.8W	ACPI vI.0	MMX	SDR100	v2.I	No	2 Ch., UDMA-33	3 Ports, vl.0	I LDRQ	AC97 v2.0	3/I	ACCESS.bus w/2 Ports	I	27	No	TFT: 1280x1024

Note I. The Geode NX I750@I4W processor operates at I.4 GHz, the Geode NX I500@6W processor operates at I.0 GHz, and the Geode NX I250@6W processor operates at 667 MHz. Model numbers reflect performance as described here: http://www.amd.com/connectivitysolutions/geodenxbenchmark.

Note 2. The Geode GX 533@I.IW processor operates at 400 MHz, the Geode GX 500@I.0W processor operates at 366 MHz, and the Geode GX 466@0.9W processor operates at 333 MHz. Model numbers reflect performance as described here: http://www.amd.com/connectivitysolutions/geodegxbenchmark.

Note 3. AMD no longer recommends new designs with the Geode GXI processor.

Developm	ent Boards																								
		OS (Note I) I/O Connectors													Typical Kit Contents										
Name	Processor (* Denotes Processor shipped in Kit)	Companion Device	Form Factor (Inches)	Video Output	Windows® XP/XPe	Windows CE 4.2 (Note 2)	Linux 2.4.x	Audio Out Channels	USB	PCI Slots	LPC Slots or Headers	Super I/O on Board	Ethernet on Board	Power	Serial ATA	IDE UDMA	Serial Ports	PS/2 Keyboard/Mouse	Parallel Port	IrDA	5.0V to 3.3V PCI Card	TFT Interface Card	LPC Card with Super I/O	PCI Ethernet Card	CD-ROM/Std. Documentation
AMD Alchemy																									
DBAul550™	Au1550™*	N/A	8.25x6.75	CRT		/	/	2	2	2 (Note 3)			2	12VDC		Ι	2	1							/
DBAul500™	Au1500™*	N/A	7.75x6xI	CRT		1	/	2	2	I (Note 3)			2	12VDC		ı	2	ı							/
DBAul200™	AuI200™*	N/A	8.25x6.75	CRT, S-Video, LCD		1	/	2	2				1	12VDC		ı	2								/
DBAull00™	AuII00™*	N/A	8x6xl	CRT		1	/	2	1				1	12VDC			2	ı		ı					/
DBAu1000™	AuI000™*	N/A	8x6.5xl	CRT		1	/	2	2				2	12VDC			2	ı							/
AMD Geode™	Solutions																								
NX DBI500	Geode NX 1750 @ 14W Geode NX 1500 @ 6W Geode NX 1250 @ 6W (Note 4)	VIA KN400A/ VT8237	Mini-TX 6.7x6.7	TFT	√	√	√	6	4	I		I	1	ATX	2	√	I	I	1	I					√
GX DB533-C	Geode GX 533@1.1W	AMD CS5535	SOM-144	CRT	1	/	/	5	4	3 (Note 6)	Ι	Ι	Τ	ATX		/	2	Τ	Τ						1
GX DB533-T	Geode GX 500 @ 1.0W Geode GX 466 @ 0.9W (Note 5)		Flex ATX 7.5x9	TFT																		/			
DBSCI200	SC1200*/SC1201 SC2200 SC3200	N/A	ETX/ATX 7x12	CRT, TFT		√	/	2	3	4	I	_	_	ATX		1	2	1	I	1					√
DBSCI100	SCII00*	N/A	ETX/ATX 7x12	CRT, TFT		1	/	2	3	4	I	I	I	ATX		1	2	I	I	I					/
SP4SC31 (Note 7)	SC1200*/SC1201 SC2200 SC3200	N/A	ATX 9.6x12	CRT, TFT, TV		√	/	2	3	2	I			ATX		✓	2			I	√	✓	✓	√	√
SP4SC40 (Note 7)	SCII00*	N/A	ATX 9.6x12	(Note 8)		/	1	2	3	4	I			ATX		1	1			Τ	1	/	/	/	/
SP4GXIO (Note 9)	GXI*	AMD CS5530A	ATX 9.6x12	CRT, TFT			/	2	2	2		1	Τ	ATX			Ι	Ι	Τ	Τ	1	/			/

- Note I. OS support typically includes BIOS and drivers for audio, display, and bootloader if required.
- The DBAul550,™ DBAul500,™ DBAul200,™ DBAul100,™ and DBAul000™ also support Windows CE 5.0. Note 2.
- Note 3. The DBAul550 and DBAul500 support 3.3V PCI cards only.
- Note 4. The Geode NX I750@I4W processor operates at I.4 GHz, the Geode NX I500@6W processor operates at I.0 GHz, and the Geode NX I250@6W processor operates at 667 MHz. Model numbers reflect performance as described here: http://www.amd.com/connectivitysolutions/geodenxbenchmark
- Note 5. The Geode GX 533@I.IW processor operates at 400 MHz, the Geode GX 500@I.0W processor operates at 366 MHz, and the Geode GX 466@0.9W processor operates at 333 MHz. Model numbers reflect performance as described here: http://www.amd.com/connectivitysolutions/geodegxbenchmark
- Note 6. The Geode GX DB533 has a total of three slots two at 3.3V and one at 5.0V. Two slots available at 66 MHz or three slots available at 33 MHz. Note 7. The SP4SC40 and SP4SC3I are no longer available for order and have been replaced by the DBSCII00 and DBSCI200, respectively.
- Note 8. Kit includes VGA graphics card on PCI bus.
- Note 9. AMD no longer recommends new designs with the GXI processor.

About AMD

AMD (NYSE:AMD) designs and produces innovative microprocessors, Flash memory devices and low-power processor solutions for the computer, communications and

consumer electronics industries. AMD is dedicated to delivering standards-based, customer-focused solutions for technology users, ranging from enterprises and governments to individual consumers.

For more information visit www.amd.com.

For more information, please visit: www.amd.com/selectionguide



One AMD Place P.O. Box 3453 Sunnyvale, CA 94088-3453, USA Tel: 408-749-4000 or 800-538-8450 TWX: 910-339-9280 **TELEX: 34-6306**



Technical Support USA & Canada: 800-222-9323, Opt 2 or 408-749-5703 USA & Canada PC Processors Only: 408-749-3060

USA & Canada E-mail: hw.support@amd.com

Latin America E-mail (Spanish): amdsp@vermont.com.br Latin America E-mail (Portuguese): amdbr@vermont.com.br

Argentina: 0800-333-0219 Brazil: 0800-557686 Chile: 123-00-209-110 Mexico: 01-800-123-4709

Europe & UK: +44-0-1276-803299 Europe & UK Fax: +44-0-1276-803298 France: 0800-908-621

Germany: +49-89-450-53199 Italy: 800-877224 Europe E-mail: euro.tech@amd.com

China Fax: 86-10-8518-1777 Hong Kong Fax: 852-2956-0588 Japan Fax: 81-3-3346-7848 Korea Fax: 82-2-3468-2601 Taiwan Fax: 886-2-2655-7855

Asia E-mail: asia.support@amd.com

Literature Ordering On the Web: www.amd.com/support/literature.html USA & Canada: 800-222-9323, Opt I USA & Canada E-mail: amdliterature@comac.com Europe E-mail: euro.lit@amd.com

China Fax: 86-10-8518-1777 Hong Kong Fax: 852-2956-0588 Japan Fax: 81-3-3346-7848 Taiwan Fax: 886-2-2655-7855

©2005 Advanced Micro Devices, Inc. All rights reserved. AMD, the AMD Arrow logo, AMD Athlon, AMD Alchemy, Geode, and combinations thereof, AMD PowerNow!, 3DNow!, AuI000, Aul100, Aul200, Aul500, Aul550, DBAul000, DBAul100, DBAul200, DBAul500, and DBAul550 are trademarks of Advanced Micro Devices, Inc. MIPS32 is a registered trademark of MIPS Technologies, Inc. Windows is a registered trademark of Microsoft Corporation in the U.S. and/or other jurisdictions. MMX is a registered trademark of Intel Corporation in the U.S. and/or other jurisdictions. Other names are for informational purposes only and may be trademarks of their respective owners.